

300mA、微功率、超低压差(VLDO)线性稳压器

UM375xxS SOT23-5

UM375xxP SOT353

描述

UM375xx 系列是专为低功耗便携式应用而设计的 VLDO（超低压差）线性稳压器。典型输出噪声仅为 $170\mu\text{V}_{\text{RMS}}$ (UM37512), 在负载电流为100mA时的最大压差仅为200mV。UM3501 内部集成P沟道MOSFET传输晶体管无需基极电流驱动, 使该器件在300mA最大负载电流的正常工作状态下, 仅消耗90 μA 电流。

该器件的其他特性包括高输出电压精度、欠压锁定、使用小至1 μF 的超低ESR陶瓷电容器的稳定性、过温保护和输出电流限制。UM375xx 系列采用扁平的 SOT23-5 和 SOT353 封装。

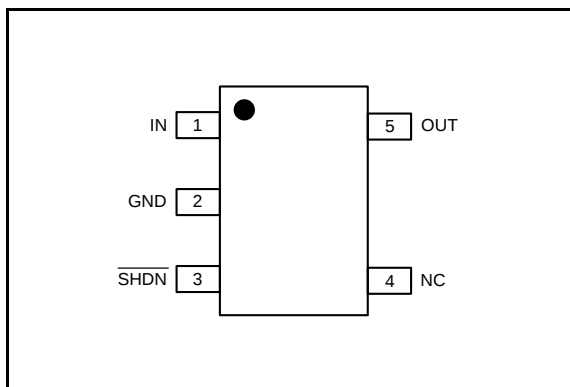
应用

- 蓝牙/802.11 板卡
- PDA 和笔记本电脑
- 便携式仪器和电池供电系统
- 蜂窝电话

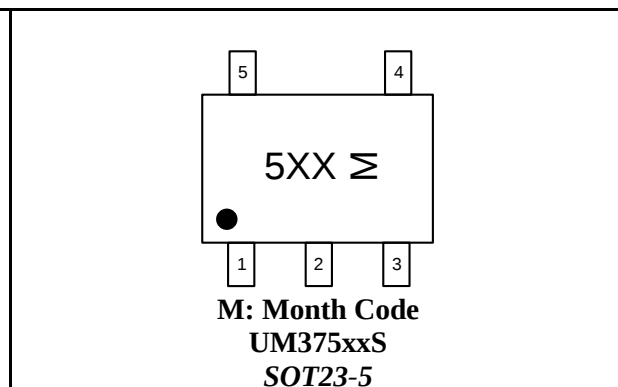
特性

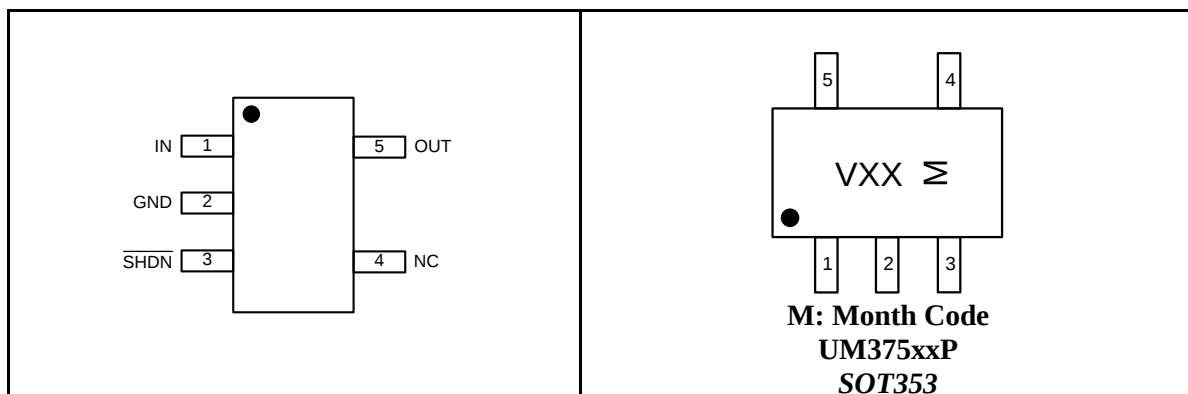
- 输入电压范围: 2.0V 至 6.0V
- 超低压差: 100mA 负载电流下压差最大 200mV
- 低噪声: $170\mu\text{V}_{\text{RMS}}$ (UM37512, 10Hz 至 100kHz)
- 在 150mA 输出电流时具有 $\pm 2\%$ 电压精度
- 固定输出电压: 1.2V 至 5.0V, 步径为 100mV
- 输出电流限制
- 使用 1 μF 输出电容, 具有良好的稳定性
- 过温保护
- 采用扁平的 SOT23-5 和 SOT353 封装

引脚配置



俯视图





Pin Description

Pin Number	Symbol	Function
1	IN	Power Supply
2	GND	Ground
3	SHDN	Shutdown Input, Active Low
4	NC	Not Connected
5	OUT	Voltage Regulated Output

Ordering Information

Part Number	Output Voltage	Packaging Type	Marking Code	Shipping Qty
UM37512S	1.2V	SOT23-5	5ED	3000pcs/7Inch Tape & Reel
UM37513S	1.3V		5EE	
UM37514S	1.4V		5EH	
UM37515S	1.5V		5EJ	
UM37516S	1.6V		5EL	
UM37517S	1.7V		5EM	
UM37518S	1.8V		5EK	
UM37519S	1.9V		5EF	
UM37520S	2.0V		5EC	
UM37521S	2.1V		5ES	
UM37522S	2.2V		5ET	
UM37523S	2.3V		5EY	
UM37524S	2.4V		5EU	
UM37525S	2.5V		5EN	
UM37526S	2.6V		5EZ	
UM37527S	2.7V		5EP	
UM37528S	2.8V		5EQ	
UM37529S	2.9V		5EB	
UM37530S	3.0V		5ER	
UM37531S	3.1V		5EA	
UM37532S	3.2V		5DD	
UM37533S	3.3V		5DE	
UM37534S	3.4V		5DB	
UM37535S	3.5V		5DF	
UM37536S	3.6V		5DH	
UM37537S	3.7V		5DA	
UM37538S	3.8V		5DL	
UM37539S	3.9V		5DT	
UM37540S	4.0V		5DM	
UM37541S	4.1V		5DY	
UM37542S	4.2V		5DJ	
UM37543S	4.3V		5DN	
UM37544S	4.4V		5DV	
UM37545S	4.5V		5DP	
UM37546S	4.6V		5DZ	
UM37547S	4.7V		5DQ	
UM37548S	4.8V		5DR	
UM37549S	4.9V		5D9	
UM37550S	5.0V		5DS	

Ordering Information (Continued)

Part Number	Output Voltage	Packaging Type	Marking Code	Shipping Qty
UM37512P	1.2V	SOT353	VL2	3000pcs/7Inch Tape & Reel
UM37513P	1.3V		VL3	
UM37514P	1.4V		VL4	
UM37515P	1.5V		VL5	
UM37516P	1.6V		VL6	
UM37517P	1.7V		VL7	
UM37518P	1.8V		VL8	
UM37519P	1.9V		VL9	
UM37520P	2.0V		VLA	
UM37521P	2.1V		VM1	
UM37522P	2.2V		VM2	
UM37523P	2.3V		VM3	
UM37524P	2.4V		VM4	
UM37525P	2.5V		VM5	
UM37526P	2.6V		VM6	
UM37527P	2.7V		VM7	
UM37528P	2.8V		VM8	
UM37529P	2.9V		VM9	
UM37530P	3.0V		VMA	
UM37531P	3.1V		VJ1	
UM37532P	3.2V		VJ2	
UM37533P	3.3V		VJ3	
UM37534P	3.4V		VJ4	
UM37535P	3.5V		VJ5	
UM37536P	3.6V		VJ6	
UM37537P	3.7V		VJ7	
UM37538P	3.8V		VJ8	
UM37539P	3.9V		VJ9	
UM37540P	4.0V		VJA	
UM37541P	4.1V		VT1	
UM37542P	4.2V		VT2	
UM37543P	4.3V		VT3	
UM37544P	4.4V		VT4	
UM37545P	4.5V		VT5	
UM37546P	4.6V		VT6	
UM37547P	4.7V		VT7	
UM37548P	4.8V		VT8	
UM37549P	4.9V		VT9	
UM37550P	5.0V		VTA	

Absolute Maximum Ratings (Note 1)

Symbol	Parameter		Value	Unit
V _{IN}	Supply Voltage on IN Pin		-0.3 to +7.5	V
V _{OUT}	Voltage on OUT Pin		-0.3 to +7.5	V
T _J	Operating Junction Temperature (Note 2, 3)		-40 to +125	°C
T _{STG}	Storage Temperature Range		-65 to +150	°C
T _L	Lead Temperature for Soldering 10 Seconds		+300	°C
P _D (Note 4)	Power Dissipation @ 25 °C	SOT23-5	0.6	W
		SOT353	0.55	

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: The UM375xx is tested and specified under pulse load conditions such that $T_J \approx T_A$. The device is guaranteed to meet performance specifications from 0 °C to 70 °C. Specifications over the -40 °C to 125 °C operating junction temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 125 °C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

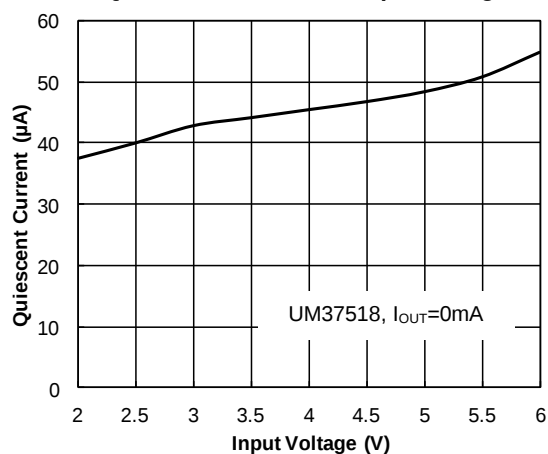
Note 4: The maximum allowable power dissipation of any T_A (ambient temperature) is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature and the regulator will go into thermal shutdown.

Electrical Characteristics
 $V_{CC}=V_{OUT}+1V$ ($V_{OUT}\geq 1.5V$) or $V_{CC}=2.5V$ ($V_{OUT}\leq 1.5V$), $T_A=-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$.

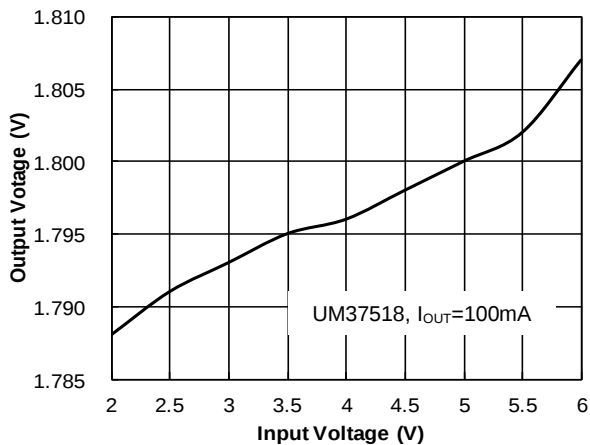
Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
V _{IN}	Input Voltage Range			2.0		6	V
V _{OUT}	Output Voltage Range			1.2		5.0	V
I _Q	Operating Quiescent Current	I _{OUT} =0mA			50	120	μA
		I _{OUT} =300mA			90	130	
I _{SHDN}	SHDN Input Current	SHDN=V _{IN} or GND				1	μA
I _{OUT}	Output Current			300			mA
	Output Voltage Accuracy	1mA≤I _{OUT} ≤300mA, T _A =-40 ℃ to +85 ℃		-2.5		+2.5	%
ΔV _{DO}	Dropout Voltage	I _{OUT} =100mA			150	200	mV
I _{LIMIT}	Output Current Limit			330	450	700	mA
t	Startup Time Response	R _L =68Ω, C _{OUT} =1μF			40		μs
V _{IL}	SHDN Input Low Voltage					0.4	V
V _{IH}	SHDN Input High Voltage			0.6V _{CC}			V
	Output Voltage TC				100		ppm/℃
T _{SHDN}	Thermal-Shutdown Temperature				160		℃
ΔT _{SHDN}	Thermal-Shutdown Hysteresis				35		℃
	Line Regulation (V _{OUT} >4.0V)	V _{OUT} +0.3V≤V _{IN} ≤6.0V or V _{IN} >2.5V I _{OUT} =10mA				0.5	%V
	Line Regulation (V _{OUT} ≤4.0V)					0.3	
	Load Regulation (V _{OUT} >4.0V)	V _{IN} =V _{OUT} +1V or V _{IN} >2.5V 1mA≤I _{OUT} ≤300mA				1.2	%
	Load Regulation (V _{OUT} ≤4.0V)					0.6	
	Output Voltage Noise	10Hz to 100kHz C _{IN} =1μF, I _{OUT} =10mA	UM37512		170		μV _{RMS}
			UM37533		250		
			UM37550		295		
PSRR	Power Supply Ripple Rejection (V _{OUT} >4.0V)	V _{IN} =V _{OUT} +1V or V _{IN} >2.5V I _{OUT} =100mA	f=100Hz	40			dB
			f=10kHz	30			
	Power Supply Ripple Rejection (V _{OUT} ≤4.0V)		f=100Hz	60			
			f=10kHz	30			
	ESD Rating	Human Body Mode		2			kV

Typical Performance Characteristics

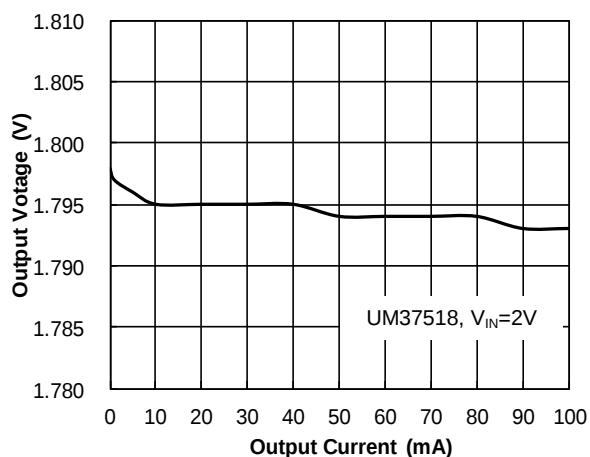
Quiescent Current vs. Input Voltage



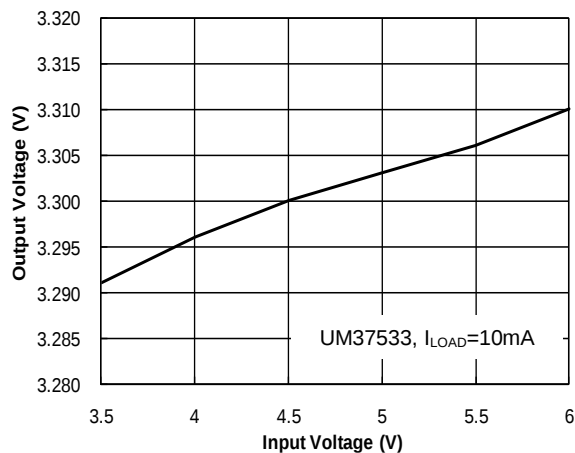
Output Voltage vs. Input Voltage



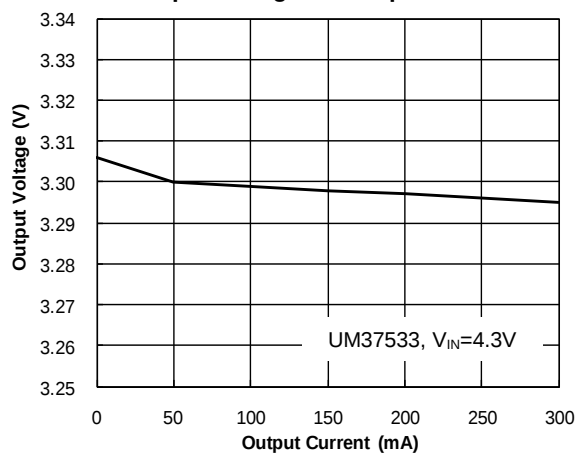
Output Voltage vs. Output Current



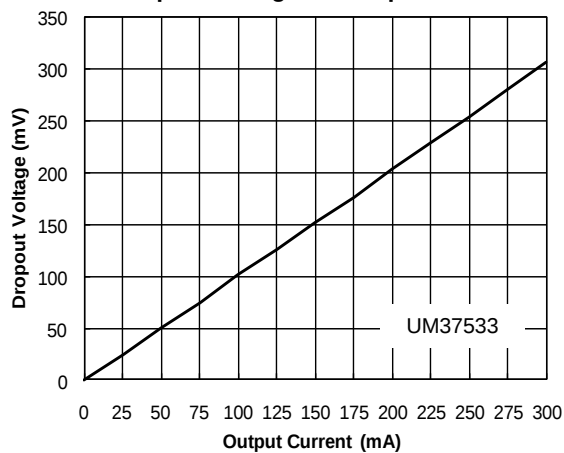
Output Voltage vs. Input Voltage



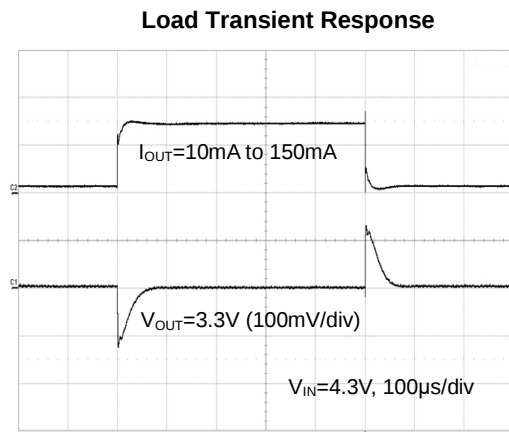
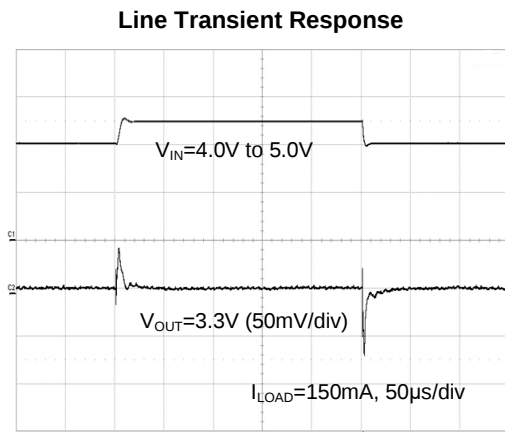
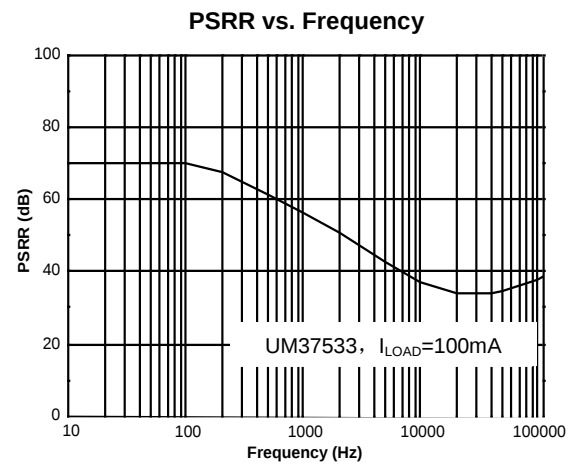
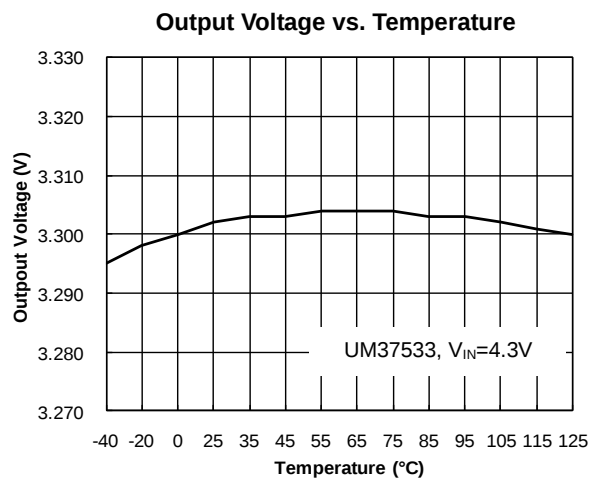
Output Voltage vs. Output Current



Dropout Voltage vs. Output Current



Typical Performance Characteristics (Continued)



Pin Function

IN (Pin 1): Power for UM375xx and Load Power is supplied to the devices through the IN pin. The IN pin should be locally bypassed to ground if the UM375xx series are more than a few inches away from another source of bulk capacitance. In general, the output impedance of a battery rises with frequency, so it is usually advisable to include an input bypass capacitor in battery-powered circuits. A capacitor in the range of 0.1 μ F to 1 μ F is usually sufficient.

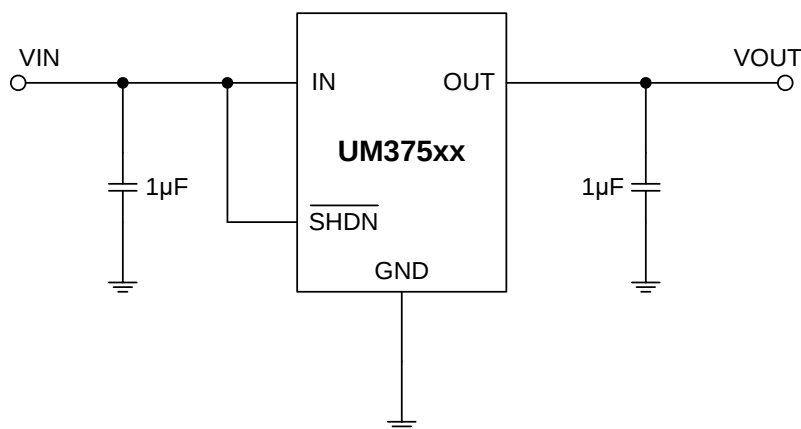
GND (Pin 2): Ground and Heat Sink. Solder to a ground plane or large pad to maximize heat dissipation.

$\overline{\text{SHDN}}$ (Pin 3): Shutdown, Active Low. This pin is used to put the UM375xx into shutdown. The $\overline{\text{SHDN}}$ pin cannot be left floating and must be tied to the input pin if not used.

NC (Pin 4): Not Connected.

OUT (Pin 5): Voltage Regulated Output. The OUT pin supplies power to the load. A minimum output capacitor of 1 μ F is required to ensure stability. Larger output capacitors may be required for applications with large transient loads to limit peak voltage transients.

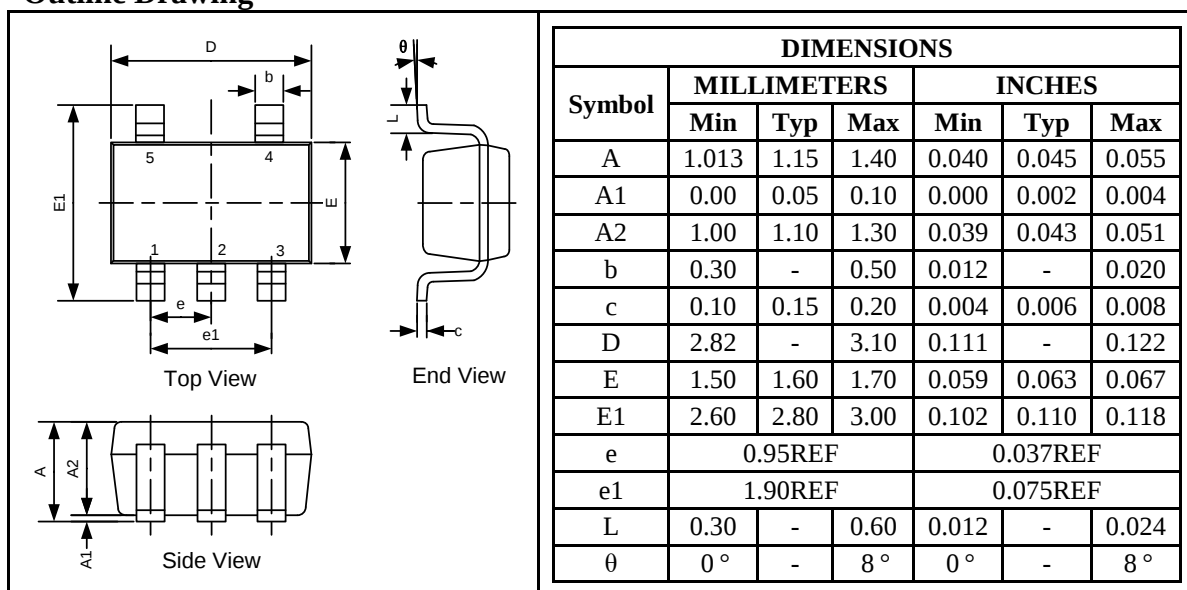
Typical Application Circuit



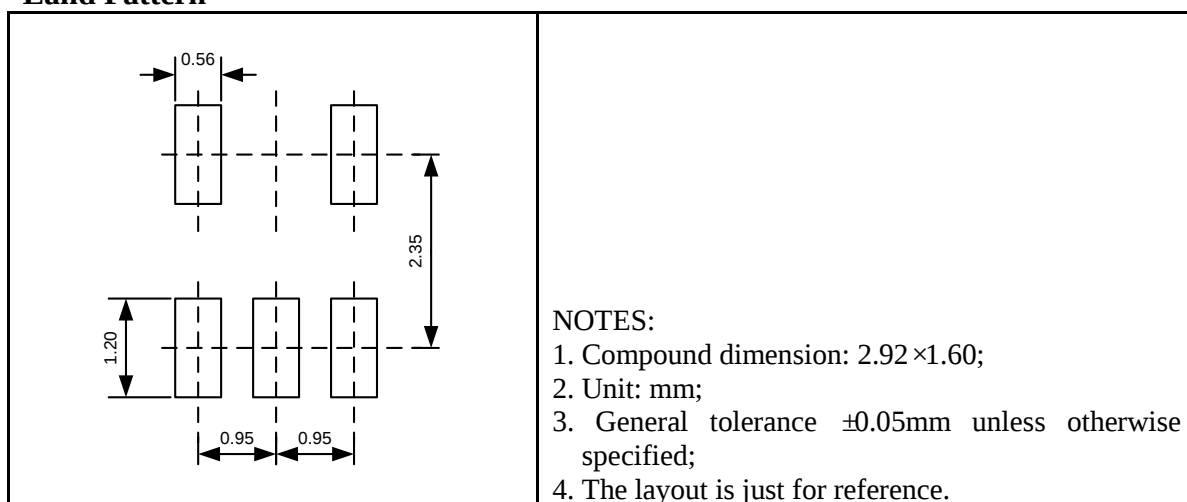
Package Information

UM375xxS: SOT23-5

Outline Drawing



Land Pattern



Tape and Reel Orientation

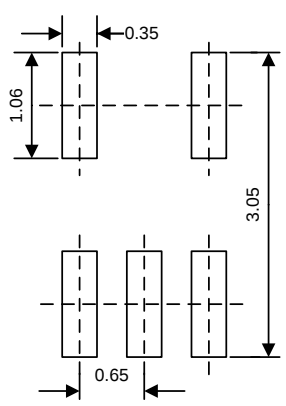


UM375xxP: SOT353

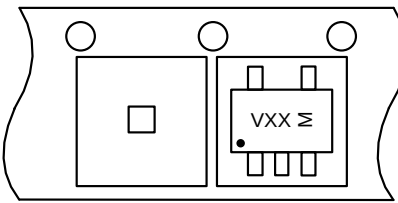
Outline Drawing

DIMENSIONS						
Symbol	MILLIMETERS			INCHES		
	Min	Typ	Max	Min	Typ	Max
A	0.85	-	1.10	0.033	-	0.043
A1	0.00	-	0.10	0.000	-	0.004
A2	0.80	-	1.00	0.031	-	0.039
b	0.10	-	0.35	0.004	-	0.014
c	0.08	-	0.22	0.003	-	0.009
D	1.80	2.15	2.20	0.071	0.085	0.087
E	1.15	1.30	1.35	0.045	0.051	0.053
E1	2.00	-	2.45	0.079	-	0.096
e	0.65BSC			0.026REF		
L	0.25	-	0.46	0.010	-	0.018
θ	0°	-	8°	0°	-	8°

Land Pattern

	NOTES: - Compound dimension: 2.15×1.30; - Unit: mm; - General tolerance $\pm 0.05\text{mm}$ unless otherwise specified; - The layout is just for reference.
---	--

Tape and Reel Orientation



GREEN COMPLIANCE

Union Semiconductor is committed to environmental excellence in all aspects of its operations including meeting or exceeding regulatory requirements with respect to the use of hazardous substances. Numerous successful programs have been implemented to reduce the use of hazardous substances and/or emissions.

All Union components are compliant with the RoHS directive, which helps to support customers in their compliance with environmental directives. For more green compliance information, please visit:

http://www.union-ic.com/index.aspx?cat_code=RoHSDeclaration

IMPORTANT NOTICE

The information in this document has been carefully reviewed and is believed to be accurate. Nonetheless, this document is subject to change without notice. Union assumes no responsibility for any inaccuracies that may be contained in this document, and makes no commitment to update or to keep current the contained information, or to notify a person or organization of any update. Union reserves the right to make changes, at any time, in order to improve reliability, function or design and to attempt to supply the best product possible.